**TOSHIBA Photocoupler Photorelay** 

# **TLP224G, TLP224G-2**

Modems PBX

**Telecommunications** 

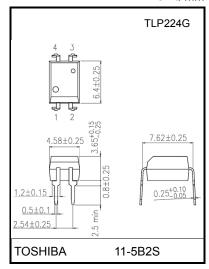
The TOSHIBA TLP224G series consists of an infrared emitting diode optically coupled to a photo-MOSFET in a 4 pin DIP (DIP4), which is suitable for equipment for high tech communications, including modems.

The TLP224G series complies with FCC part 68 rules with current.

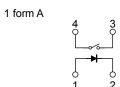
The TLP224G series complies with FCC part 68 rules with current limiting function.

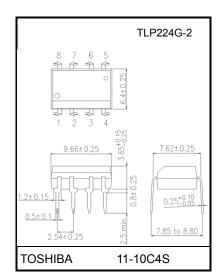
- TLP224G: 4 pin DIP, 1 channel type (1 form A)
- TLP224G-2: 8 pin DIP, 2 channel type (2 form A)
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- Load current limiting: 150 mA to 300 mA (t = 5 ms)
- On-state resistance:  $35 \Omega$  (max)
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

Unit: mm

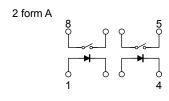


Weight: 0.26 g (typ.)





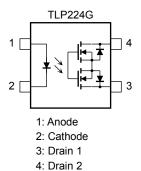
Weight: 0.54 g (typ.)

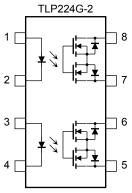


Start of commercial production 1999-09

© 2019

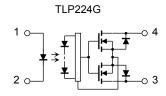
## Pin Configuration (top view)





- 1, 3: Anode
- 2, 4: Cathode
- 5: Drain 1
- 6: Drain 2
- 7: Drain 3
- 8: Drain 4

#### **Internal Circuit**



#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
	Forward current	lF	50	mA	
	Forward current derating (Ta ≥ 25°C)	ΔIF/°C	-0.5	mA/°C	
	Peak forward current (100 μs pulse, 100 pps)	lFP	1	А	
LED	Reverse voltage	$V_{R}$	6	V	
	Diode power dissipation	PD	50	mW	
	Diode power dissipation derating (Ta ≥ 25°C)	ΔPD /°C	-0.5	mW/°C	
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	Voff	350	V	
	On-state current (Note 1)	Ion	120	mA	
Detector		Δl <sub>ON</sub> /°C	-1.2	mA/°C	
Detector	Output power dissipation	Po	504	mW	
	Output power dissipation derating (Ta ≥ 25°C)	ΔP <sub>O</sub> / °C	-5.04	mW / °C	
	Junction temperature	Tj	125	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 125	°C	
Operating	Operating temperature range		−40 to 85	°C	
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C	
Isolation vo	oltage (AC, 60 s, R.H. ≤ 60 %) (Note 2)	BVs	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Two channels operating simultaneously.

Note 2: Device considered a two-terminal device: LED side pins shorted together, and detector side pins shored together.

#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	lF	5	7.5	25	mA
On-state current	Ion	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

© 2019 3 2019-06-17

## **Individual Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V <sub>R</sub> = 6 V	_	_	10	μА
	Capacitance	Ст	VF = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	V <sub>OFF</sub> = 350 V	_	_	1	μА
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz	_	40	_	pF

## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	lfT	I <sub>ON</sub> = 120 mA	-	1	3	mA
Return LED current	IFC	I <sub>OFF</sub> = 10 μA	0.1	0.4	_	mA
Load current limiting	I <sub>LIM</sub>	$I_F = 5 \text{ mA}, V_{DD} = 5 \text{ V}, t = 5 \text{ ms}$	150	1	300	mA
On-state resistance	Ron	$I_{ON} = 120 \text{ mA}, I_F = 5 \text{ mA}$	_	22	35	Ω

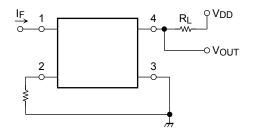
## Isolation Characteristics (Ta = 25°C)

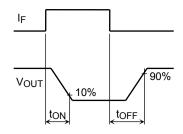
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	2500	_	_	Vrms

## **Switching Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note) $V_{CC} = 20 \text{ V}, \text{ IF} = 5 \text{ mA}$	_	_	1	ms
Turn-off time	toff	$R_L = 200 \ \Omega$ (Note) $V_{CC} = 20 \ V, \ I_F = 5 \ mA$	_	_	1	ms

Note: Switching time test circuit





© 2019
Toshiba Electronic Devices & Storage Corporation

4
2019-06-17

#### **RESTRICTIONS ON PRODUCT USE**

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical
  equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to
  control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative or contact us via our website.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
  limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
  technology products (mass destruction weapons). Product and related software and technology may be controlled under the
  applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the
  U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited
  except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of
  Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled
  substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
  OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

## **TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION**

https://toshiba.semicon-storage.com/

## 单击下面可查看定价,库存,交付和生命周期等信息

>>Toshiba(东芝)